

AO4812A

Dual N-Channel Enhancement Mode Field Effect Transistor

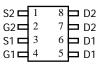
General Description

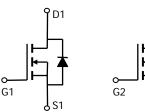
The AO4812A uses advanced trench technology to provide excellent $R_{DS(ON)}$ and low gate charge. The two MOSFETs make a compact and efficient switch and synchronous rectifier combination for use in buck converters. AO4812A is Pb-free (meets ROHS & Sony 259 specifications). AO4812AL is a Green Product ordering option. AO4812A and AO4812AL are electrically identical.

Features

$$\begin{split} &V_{DS} \; (V) = 30V \\ &I_{D} = 6.9A \; \; (V_{GS} = 10V) \\ &R_{DS(ON)} < 28m\Omega \; (V_{GS} = 10V) \\ &R_{DS(ON)} < 42m\Omega \; (V_{GS} = 4.5V) \end{split}$$

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SOIC-8

Absolute Maximum Ratings T _A =25°C unless otherwise noted							
Parameter		Symbol	Maximum	Units			
Drain-Source Voltage		V _{DS}	30	V			
Gate-Source Voltage		V _{GS}	±20	V			
Continuous Drain	T _A =25°C		6.9				
Current ^A	T _A =70°C	I _D	5.8	A			
Pulsed Drain Current ^B		I _{DM}	30				
	T _A =25°C	D	2	10/			
Power Dissipation	T _A =70°C	– P _D –	1.44	W			
Junction and Storage Temperature Range		T _J , T _{STG}	-55 to 150	°C			

Thermal Characteristics									
Parameter	Symbol	Тур	Max	Units					
Maximum Junction-to-Ambient ^A	t ≤ 10s	R _{0JA}	50	62.5	°C/W				
Maximum Junction-to-Ambient ^A	Steady-State	Γ _θ JA	82	110	°C/W				
Maximum Junction-to-Lead ^c	Steady-State	$R_{ ext{ heta}JL}$	41	50	°C/W				

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Parameter Conditions		Min	Тур	Max	Units
STATIC F	PARAMETERS						
BV _{DSS}	Drain-Source Breakdown Voltage	I _D =250μA, V _{GS} =0V		30			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =24V, V _{GS} =0V T _J =55°C			0.004	1	μΑ
						5	
I _{GSS}	Gate-Body leakage current	V_{DS} =0V, V_{GS} = ±20V				100	nA
V _{GS(th)}	Gate Threshold Voltage	$V_{DS}=V_{GS}$ I _D =250 μ A		1	1.8	3	V
I _{D(ON)}	On state drain current	V _{GS} =4.5V, V _{DS} =5V		20			Α
R _{DS(ON)}		V _{GS} =10V, I _D =6.9A			19	28	mΩ
	Static Drain-Source On-Resistance		T _J =125°C		24	30	
		V _{GS} =4.5V, I _D =5A			28	42	mΩ
g _{FS}	Forward Transconductance	V _{DS} =5V, I _D =6.9A		10	24		S
V _{SD}	Diode Forward Voltage	I _S =1A,V _{GS} =0V			0.77	1	V
ls	Maximum Body-Diode Continuous Curr	Diode Continuous Current				4.3	Α
DYNAMI	C PARAMETERS						
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =15V, f=1MHz			621	820	pF
C _{oss}	Output Capacitance				118		pF
C _{rss}	Reverse Transfer Capacitance				85		pF
R _g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz			0.8	1.5	Ω
SWITCHI	NG PARAMETERS						
Q _g (10V)	Total Gate Charge	V _{GS} =10V, V _{DS} =15V, I _D =6.9A			11.3	17	nC
Q _g (4.5V)	Total Gate Charge				5.7	8	nC
Q _{gs}	Gate Source Charge				2.1		nC
Q_{gd}	Gate Drain Charge				3		nC
t _{D(on)}	Turn-On DelayTime	V _{GS} =10V, V _{DS} =15V, R _L =2.2Ω, R _{GEN} =3Ω			4.5	6.5	ns
t _r	Turn-On Rise Time				3.1	5	ns
t _{D(off)}	Turn-Off DelayTime				15.1	23	ns
t _f	Turn-Off Fall Time				2.7	5	ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =6.9A, dI/dt=100A/μs			15.5	20	ns
Q _{rr}	Body Diode Reverse Recovery Charge	e I _F =6.9A, dI/dt=100A/μs			7.1	10	nC

A: The value of R_{BUA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^{\circ}C$. The value in any given application depends on the user's specific board design. The current rating is based on the t \leq 10s thermal resistance rating. B: Repetitive rating, pulse width limited by junction temperature.

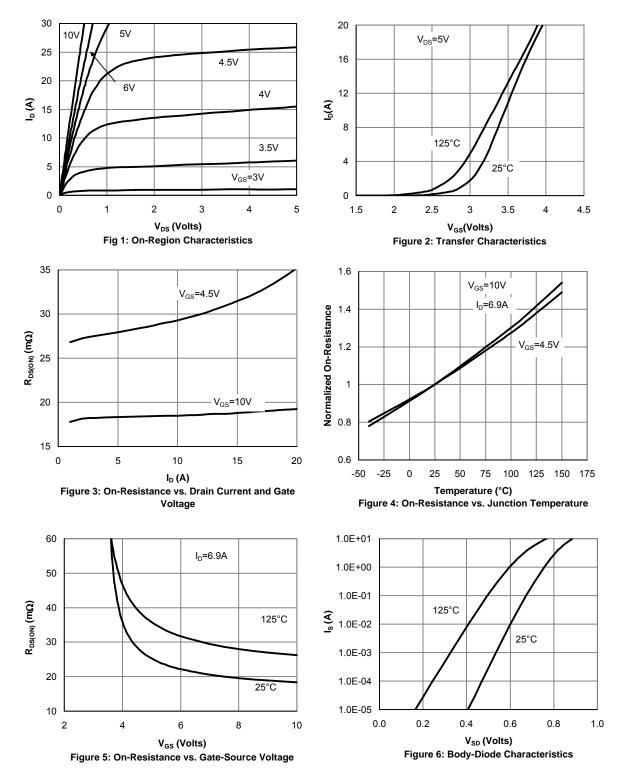
C. The R $_{\theta JA}$ is the sum of the thermal impedence from junction to lead R $_{\theta JL}$ and lead to ambient.

D. The static characteristics in Figures 1 to 6 are obtained using 80 µs pulses, duty cycle 0.5% max.

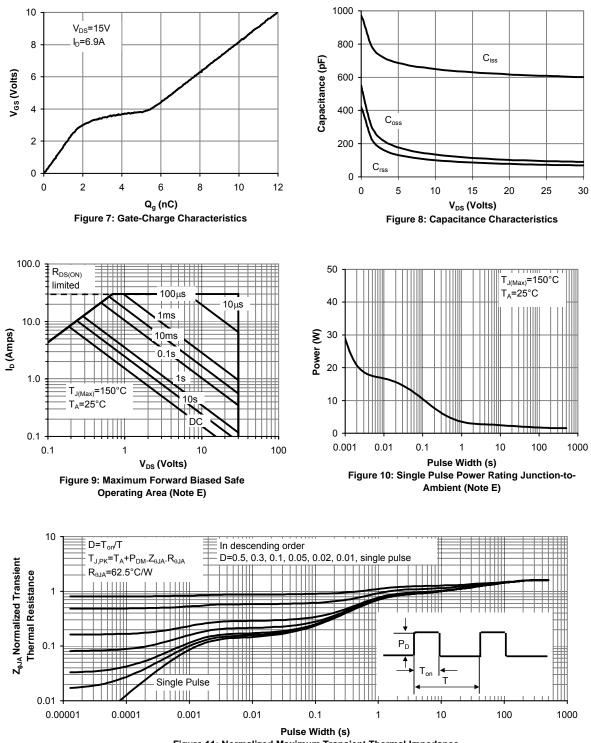
E. These tests are performed with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^{\circ}$ C. The SOA curve provides a single pulse rating.

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



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Figure 11: Normalized Maximum Transient Thermal Impedance